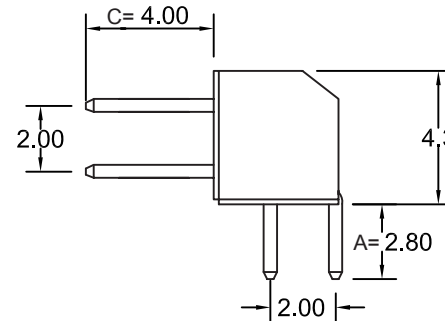
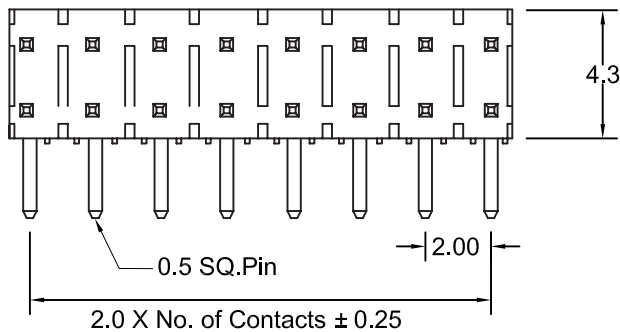
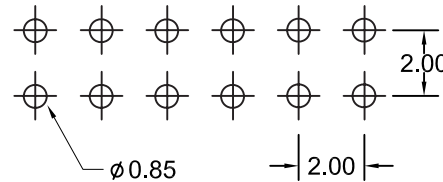


### Recommended P.C. Board Hole Layout



## Specifications

Current Rating: 3 Amps  
 Insulator Resistance: 1000 Megohms min.  
 Contact Resistance: 20 m ohms max.  
 Dielectric Withstanding: AC 600V  
 Operating Temperature:  $-40^{\circ}\text{C} \sim +105^{\circ}\text{C}$   
 Contact Material: Brass  
 Insulator Material: Polyester, UL 94V-0, Nylon-6T  
 Contact Plated: \*see options below  
 Standard: Gold Flash

## Part Numbering System

**RD200-H4.3 - XX - A-C- X B**

Series ————  
 No. of Pins ————  
 Terminal Dimensions Required  
 A = ... , C = ...  
 Contact Plating ————  
 Packing Method: ————  
 B = Tube

**Example: RD200-H4.3-08-2.80-4.00-GB**  
 with 8 pins, A= 2.80, C= 4.00

* Contact Plating Option	Full Gold Plating	Gold Plated On Contact Area Tin Plated on Solder Area	Full Tin Plating
	G : Gold Flash G10: Gold 10u" G15: Gold 15u" G30: Gold 30u"	S: Gold Flash S10: Gold 10u" S15: Gold 15u" S30: Gold 30u"	T: Tin 100u"

General Tolerance	
X. $\pm 0.50$	X.° $\pm 5^{\circ}$
.X $\pm 0.20$	.X° $\pm 2^{\circ}$
.XX $\pm 0.10$	.XX° $\pm 1^{\circ}$
Units : mm	